

FLEXcon® THERMLfilm® HT™ for Printed Circuit Board Labeling

Compare and Choose		Non-Wave Solder		Wave Solder	
		P12W50G P12W150P P12W50K	P11W50G P11W150P P11W50K	9000 9001	9002 9003
Film thickness		2 mils	1 mil	2 mils	1 mil
Withstands intermittent heat up to 750°F/398°C		•	•	•	•
Leaded and lead-free reflow		•	•	•	•
Wave solder				•	•
Printability at 600 DPI		•	•	•	•
Halogen-free; REACH and RoHS compliant		•	•	•	•
Available In pre-slit rolls		•	•		
UL and/or cUL recognized with these ribbons	DNP R510HF			UL/cUL	UL/cUL
	limak SP575			UL/cUL	UL/cUL
	ITW Coding Products 7993			UL/cUL	UL/cUL
	Ricoh B110CR			UL/cUL	UL/cUL
	Armor AXR 1			UL/cUL	UL/cUL
	ITW Thermal Films B814			UL	UL
	Armor AXR 8	UL/cUL	UL/cUL		
	Armor AXR 800	UL/cUL	UL/cUL		
	Kurz K504	UL/cUL	UL/cUL		
	Zebra Technologies Corp 5100	UL/cUL	UL/cUL		
	Armor AXR 7+	UL	UL		
	DNP R510	UL	UL		
	DNP TR4070	UL	UL		
	ITW Coding Products 7993	UL	UL		
	ITW Thermal Films B324	UL	UL		
	ITW Thermal Films B813	UL	UL		
	limak SP-330	UL	UL		
	limak SP-990	UL	UL		
	Ricoh B110C	UL	UL		
	Sato Corp R335A	UL	UL		
Sato Corp R335C	UL	UL			

- 1 or 2 mil polyimide endures printed circuit board cleaning environments
- Tested and approved for leaded and lead-free reflow (top and bottom)
- Durable thermal transfer printable topcoats
- Permanent pressure-sensitive adhesives bond well to standard PCBs
- Low outgassing of adhesive
- Available on a variety of liners
- Suitable for high-temperature automotive and electronics applications.



Feel confident that your printed circuit board labels will perform as expected.

www.FLEXcon.com/THERMLfilmHT

Order Samples Today!